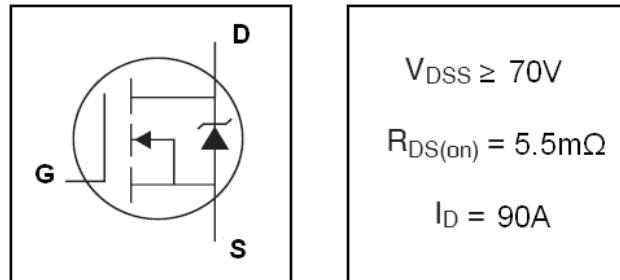


## Features

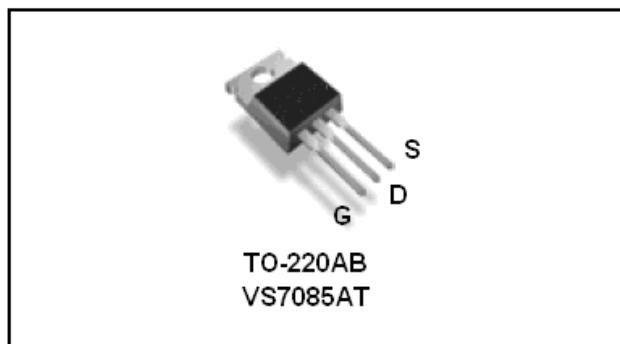
- ◆ Low On-Resistance
- ◆ Fast Switching
- ◆ 100% Avalanche Tested
- ◆ Repetitive Avalanche Allowed up to  $T_{jmax}$
- ◆ Lead-Free, RoHS Compliant

## Description

VS7085AT designed by the trench processing techniques to achieve extremely low on-resistance. Additional features of this design are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating . These features combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.



$V_{DSS} \geq 70V$   
 $R_{DS(on)} = 5.5m\Omega$   
 $I_D = 90A$



## Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (TA) is 25°C, unless otherwise specified.

Symbol	Parameter	Rating	Unit
<b>Common Ratings (T<sub>c</sub>=25°C Unless Otherwise Noted)</b>			
$V_{GS}$	Gate-Source Voltage	±20	V
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	70	V
$T_J$	Maximum Junction Temperature	175	°C
$T_{STG}$	Storage Temperature Range	-55 to 175	°C
$I_S$	Diode Continuous Forward Current	$T_c=25^\circ C$	A

## Mounted on Large Heat Sink

$I_{DM}$	Pulse Drain Current Tested ①	$T_c=25^\circ C$	360	A
$I_D$	Continuous Drain current@ $V_{GS}=10V$	$T_c=25^\circ C$	90	A
$P_D$	Maximum Power Dissipation	$T_c=25^\circ C$	175	W
$R_{\theta JC}$	Thermal Resistance-Junction to Case		0.85	°C/W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient		62.5	°C/W

## Drain-Source Avalanche Ratings

EAS	Avalanche Energy, Single Pulsed ②	325	mJ
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Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ <math>T_J = 25^\circ\text{C}</math> (Unless otherwise stated)</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	70	--	--	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current( $T_c=25^\circ\text{C}$ )	$V_{\text{DS}}=64\text{V}, V_{\text{GS}}=0\text{V}$	--	--	1	$\mu\text{A}$
	Zero Gate Voltage Drain Current( $T_c=125^\circ\text{C}$ )	$V_{\text{DS}}=64\text{V}, V_{\text{GS}}=0\text{V}$	--	--	100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	--	--	$\pm 100$	nA
$V_{\text{GS(TH)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2	3	4	V
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance <sup>①</sup>	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=40\text{A}$	--	5.5	7	$\text{m}\Omega$
<b>Dynamic Electrical Characteristics @ <math>T_J = 25^\circ\text{C}</math> (Unless otherwise stated)</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=48\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	--	3460	--	pF
$C_{\text{oss}}$	Output Capacitance		--	400	--	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		--	175	--	pF
$Q_g$	Total Gate Charge	$V_{\text{DS}}=35\text{V}, I_{\text{D}}=40\text{A}, V_{\text{GS}}=10\text{V}$	--	56	--	nC
$Q_{\text{gs}}$	Gate-Source Charge		--	13.5	--	nC
$Q_{\text{gd}}$	Gate-Drain Charge		--	15.6	--	nC
<b>Switching Characteristics</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=35\text{V}, I_{\text{D}}=20\text{A}, R_{\text{G}}=6.8\Omega, V_{\text{GS}}=10\text{V}$	--	11.5	--	nS
$t_r$	Turn-on Rise Time		--	35	--	nS
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	48	--	nS
$t_f$	Turn-Off Fall Time		--	28	--	nS
<b>Source- Drain Diode Characteristics@ <math>T_J = 25^\circ\text{C}</math> (Unless otherwise stated)</b>						
$V_{\text{SD}}$	Forward on voltage	$I_{\text{SD}}=45\text{A}, V_{\text{GS}}=0\text{V}$	--	--	1.3	V
$t_{\text{rr}}$	Reverse Recovery Time	$T_j=25^\circ\text{C}, I_{\text{sd}}=40\text{A}, V_{\text{GS}}=0\text{V}$ $dI/dt=100\text{A}/\mu\text{s}$	--	46	--	nS
$Q_{\text{rr}}$	Reverse Recovery Charge			90		nC

NOTE:

①Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ .

② Limited by  $T_{J\text{max}}$ , starting  $T_J = 25^\circ\text{C}$ ,  $L = 0.5\text{mH}$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 28\text{A}$ ,  $V_{GS} = 10\text{V}$ . Part not recommended for use above this value

## Typical Characteristics

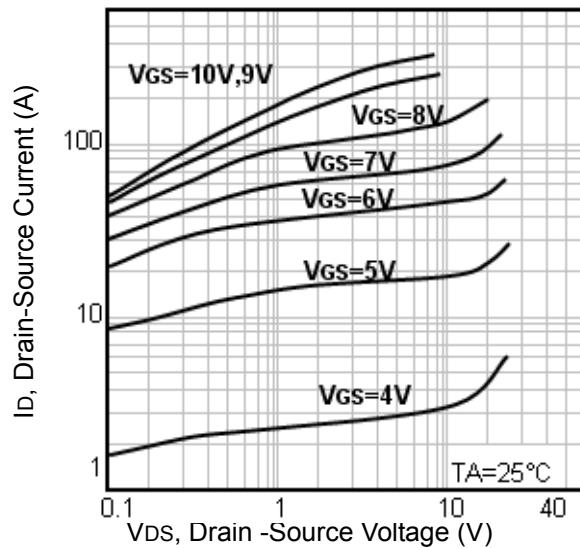


Fig1. Typical Output Characteristics

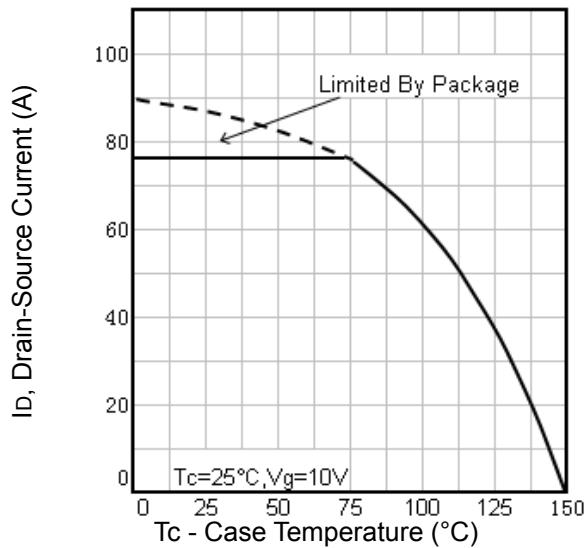


Fig2. Maximum Drain Current Vs. Case Temperature

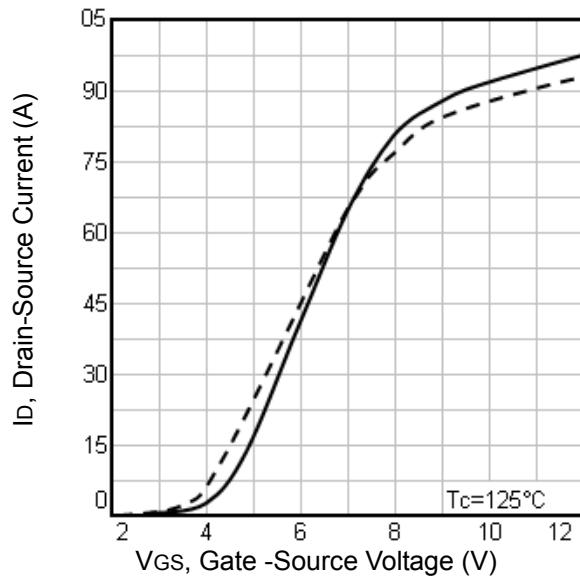


Fig3. Typical Transfer Characteristics

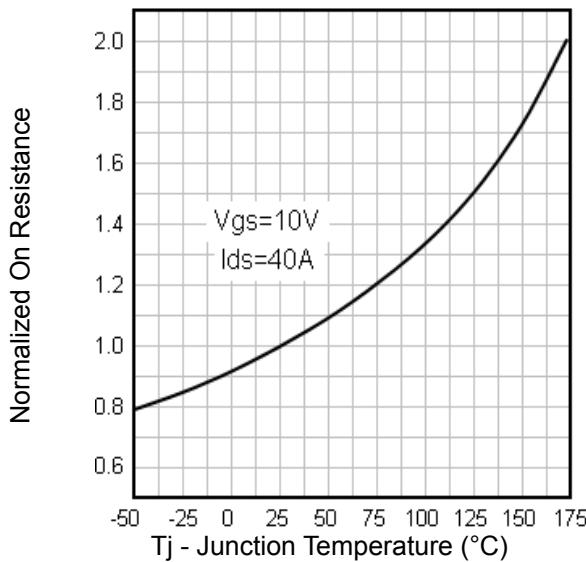


Fig4. Normalized On-Resistance Vs. Temperature

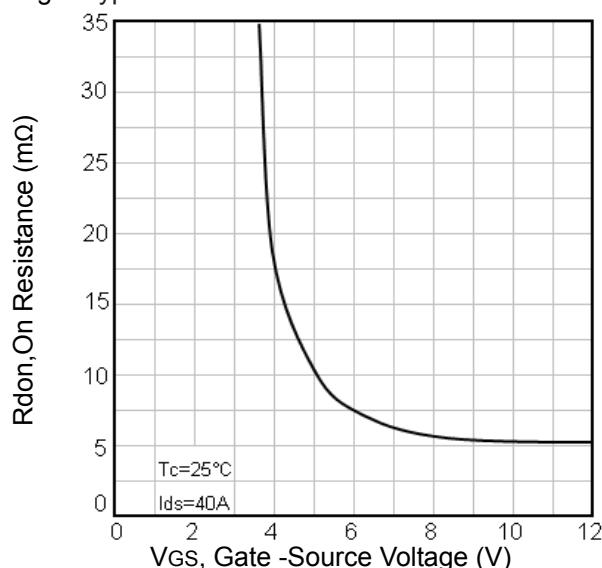


Fig5. Typical On-Resistance Vs. Gate-Source Voltage

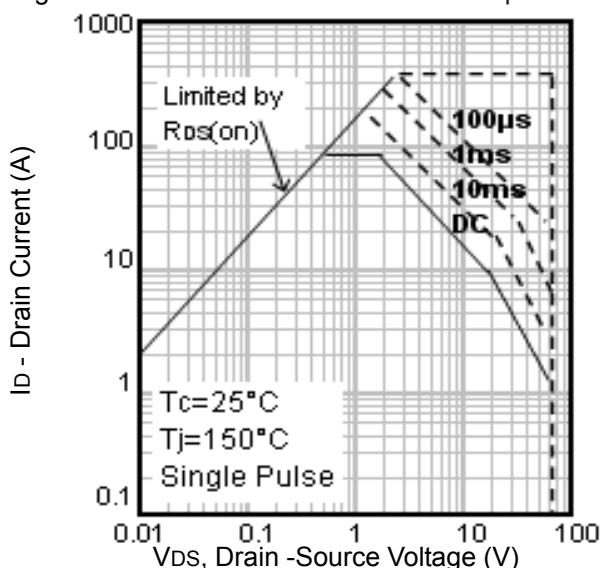


Fig6. Maximum Safe Operating Area

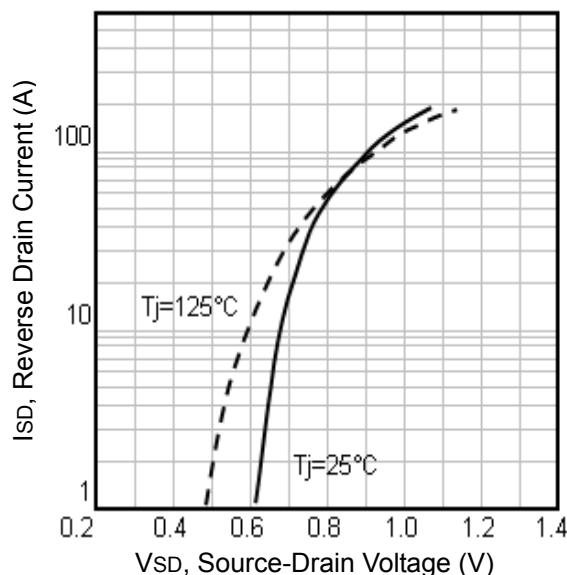


Fig7. Typical Source-Drain Diode Forward Voltage

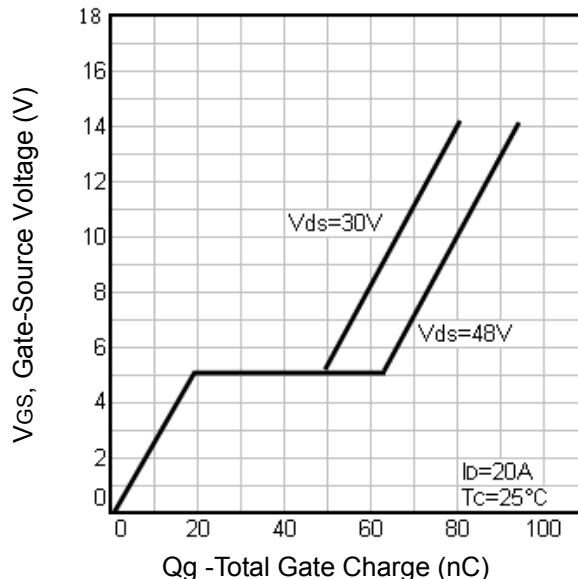


Fig8. Typical Gate Charge Vs.Gate-Source Voltage

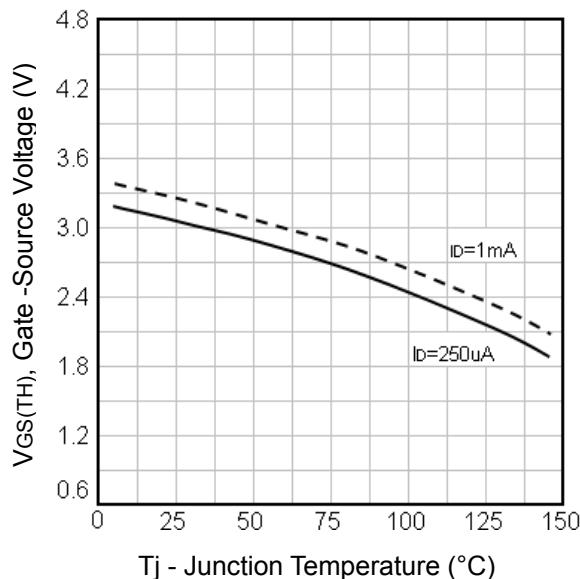


Fig9. Threshold Voltage Vs. Temperature

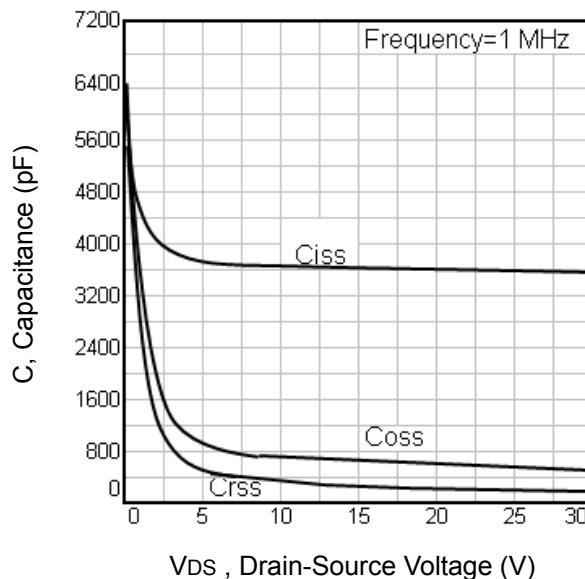


Fig10. Typical Capacitance Vs.Drain-Source Voltage

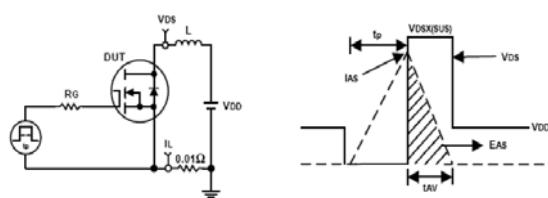


Fig11. Unclamped Inductive Test Circuit and waveforms

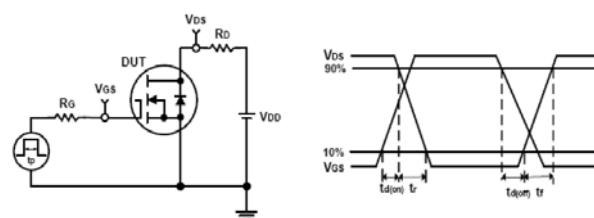
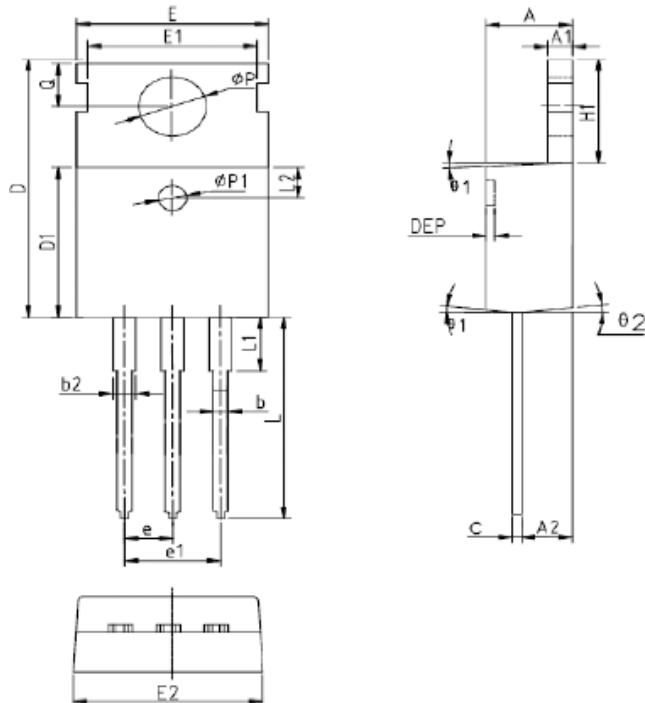


Fig12. Switching Time Test Circuit and waveforms

## TO-220AB Package Outline



SYMBOL	MM			INCH			SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX		MIN	NOM	MAX	MIN	NOM	MAX
A	4.40	4.57	4.70	0.173	0.180	0.185	φp1	1.40	1.50	1.60	0.055	0.059	0.063
A1	1.27	1.30	1.33	0.050	0.051	0.052	e	2.54BSC			0.1BSC		
A2	2.35	2.40	2.50	0.093	0.094	0.098	ε1	5.08BSC			0.2BSC		
b	0.77	-	0.90	0.030	-	0.035	H1	6.40	6.50	6.60	0.252	0.256	0.260
b2	1.23	-	1.36	0.048	-	0.054	L	12.75	-	13.17	0.502	-	0.519
C	0.48	0.50	0.52	0.019	0.020	0.021	L1	-	-	3.95	-	-	0.156
D	15.40	15.60	15.80	0.606	0.614	0.622	L2	2.50REF			0.098REF		
D1	9.00	9.10	9.20	0.354	0.358	0.362	φp	3.57	3.60	3.63	0.141	0.142	0.143
DEP	0.05	0.10	0.20	0.002	0.004	0.008	Q	2.73	2.80	2.87	0.107	0.110	0.113
E	9.70	9.90	10.10	0.382	0.389	0.398	θ1	5°	7°	9°	5°	7°	9°
E1	-	8.70	-	-	0.343	-	θ2	1°	3°	5°	1°	3°	5°
E2	9.80	10.00	10.20	0.386	0.394	0.401							

## Order Information

Product	Marking	Package	Packaging	Min Unit Quantity
VS7085AT	VS7085AT	TO-220AB	50PCS/Tube	1000PCS

## Customer Service

### Sales and Service:

sales@vgsemi.com

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